

• HW $#2$

Carlo Segre (Illinois Tech) **[PHYS 570 - Fall 2024](#page-0-0)** September 09, 2024 1/28

- HW $#2$
- APSU and other sources

Carlo Segre (Illinois Tech) **[PHYS 570 - Fall 2024](#page-0-0)** September 09, 2024 1/28

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- Detectors
	- Gas detectors
	- Scintillation counters
	- Solid state detectors
	- Area detectors

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Reading Assignment: Chapter 3.4

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Reading Assignment: Chapter 3.4

Homework Assignment #02: Problems on Canvas due Monday, September 16, 2024

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	- Solid state detectors
	- Area detectors

Reading Assignment: Chapter 3.4

Homework Assignment #02: Problems on Canvas due Monday, September 16, 2024

Homework Assignment #03: Chapter 3: 1,3,4,6,8 due Monday, September 30, 2024

HW $#02$

1. Knowing that the photoelectric absorption of an element scales as the inverse of the energy cubed, calculate:

- (a) the absorption coefficient at 10keV for copper when the value at 5keV is 1698.3 cm $^{-1};$
- (b) The actual absorption coefficient of copper at 10keV is 1942.1 cm $^{-1}$, why is this so different than your calculated value?

2. A 30 cm long, ionization chamber, filled with 80% helium and 20% nitrogen gases at 1 atmosphere, is being used to measure the photon rate (photons/sec) in a synchrotron beamline at 12 keV. If a current of 10 nA is measured, what is the photon flux entering the ionization chamber?

3. A 5 cm deep ionization chamber is used to measure the fluorescence from a sample containing arsenic (As). Using any noble gases or nitrogen, determine a gas fill (at 1 atmosphere) for this chamber which absorbs at least 60% of the incident photons. How does this change if you are measuring the fluorescence from ruthenium (Ru)?

HW $#02$

4. Calculate the critical angle of reflection of 10 keV and 30 keV x-rays for:

- (a) A slab of glass $(SiO₂)$:
- (b) A thick chromium mirror;
- (c) A thick platinum mirror.
- (d) If the incident x-ray beam is 2 mm high, what length of mirror is required to reflect the entire beam for each material?

5. Calculate the fraction of silver (Ag) fluorescence x-rays which are absorbed in a 1 mm thick silicon (Si) detector and the charge pulse expected for each absorbed photon. Repeat the calculation for a 1 mm thick germanium (Ge) detector.

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The beam will be nearly square and there will be much more coherence from the undulators

Carlo Segre (Illinois Tech) **[PHYS 570 - Fall 2024](#page-0-0)** September 09, 2024 4/28

APS-U magnet layout

The APS upgrade will install a multi-bend achromat instead of the two bending magnets.

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two dipole magnets - double-bend-achromat

Seven dipole magnets - multi-bend-achromat (MBA)

APS-U undulator performance

The multi-bend achromat will produce a diffraction-limited source with a lower energy (6.0 GeV) and doubled current (200 mA).

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The APS-U is an example of a " $4th$ " generation synchrotron source

Initial electron cloud, each electron emits coherently but independently

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Over course of 100 m, electric field of photons, feeds back on the electron bunch

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Again, an alternative way to view this is that the pulse train from a 100m long undulator is long enough in time to produce a monochromatic and coherent frequency distribution when Fourier Transformed

FEL performance

An FEL has a single accelerator whose electron beam is shunted sequentially through different undulators and end stations

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The high brightness usually results in destruction of the sample during the illumination, thus the need for multiple samples and multiple shot experiments

Small low energy, high current electron ring

Carlo Segre (Illinois Tech) [PHYS 570 - Fall 2024](#page-0-0) September 09, 2024 10 / 28

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Cost ∼\$5 M plus ∼\$1 M per year service contract

Gas detectors

• Ionization chamber

- Ionization chamber
- Proportional counter

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- Proportional counter
- Geiger-Muller tube

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Charge coupled device detectors

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Charge coupled device detectors

• Indirect

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Scintillation counters Solid state detectors

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Charge coupled device detectors

- Indirect
- Direct coupled

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The most useful regime is the ionization region where the output pulse is independent of the applied voltage over a wide range

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- 22-41 eV per electron-ion pair (depending on the gas) makes this useful for quantitative measurements.

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Ionization Chamber [nA] [kHz]

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the tiny current is fed into an sensitive amplifier with gains of up to 10^{10} which outputs a voltage signal of 1-10 V that tracks the input with an adjustable time constant

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the digital pulse train is counted by a scaler for a user-definable length of time

Useful for photon counting experiments with rates less than $10^4/s$

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- Output voltage pulse is proportional to initial x-ray energy.

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if the voltage pulse falls within the discriminator window, a short digital pulse is output from the discriminator and into a scaler for counting

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because of the small energy required to produce an electron-hole pair, one x-ray photon will create many and its energy can be detected with very high resolution

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the device to make a measurement

Semiconductor junctions

start with two pieces of semiconductor, one n-type and the other p-type

if these two materials are brought into contact, a natural depletion region is formed where there is an electric field $\vec{\mathcal{E}}$

this region is called an intrinsic region and is the only place where an absorbed photon can create electronhole pairs and have them be swept to the p and n This region is to is formed where there is an electron-
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by applying a reverse bias voltage, it is possible to extend the depleted region, make the effective volume of the detector larger and increase the electric field to get faster charge collection times

Silicon Drift Detector

Same principle as intrinsic or p-i-n detector but much more compact and operates at higher temperatures

Relatively low stopping power is a drawback

V

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electronics outputs input count rate (icr), output count rate (ocr), and areas of integrated pulses (A_n)

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When dead time is too large, correction will not be accurate!

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Carlo Segre (Illinois Tech) [PHYS 570 - Fall 2024](#page-0-0) September 09, 2024 22 / 28

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Will look carefully only at more modern technologies such as Charge Coupled Device (CCD) based detectors and active pixel array detectors

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The most advanced detectors can easily cost over a million dollars!

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expensive to make very large, limited sensitivity to high energies

The largest area detectors are made using the CCD in indirect mode

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Pixel sizes are usually rather large (50 μ m \times 50 μ m)

The Pixel Array Detector combines area detection with on-board electronics for fast signal processing

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The diode layer absorbs x-rays and the electronhole pairs are immediately swept into the CMOS electronics layer

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The diode layer absorbs x-rays and the electronhole pairs are immediately swept into the CMOS electronics layer

This permits fast processing and possibly energy discrimination on a per-pixel level

Pixel array detectors - Pilatus

Pixel array detector with 1,000,000 pixels.

Each pixel has energy resolving capabilities & high speed readout.

Silicon sensor limits energy range of operation.

from Swiss Light Source

High energy solutions

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The absorption can be significantly enhanced with these higher Z elements while maintaining good energy discrimination capabilities.